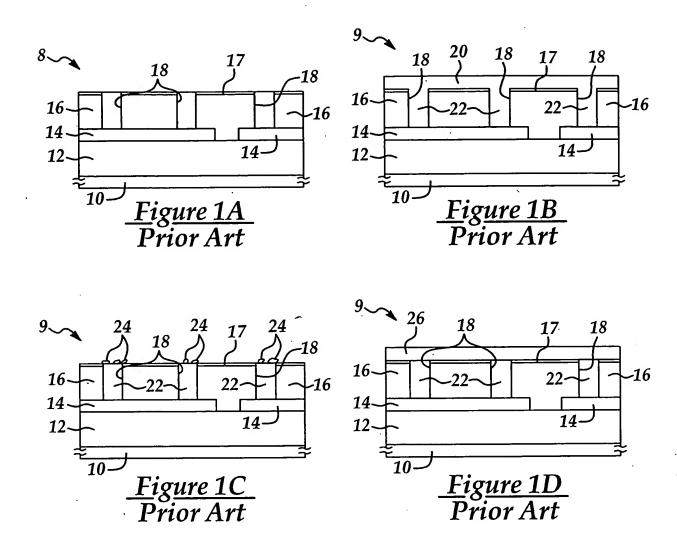
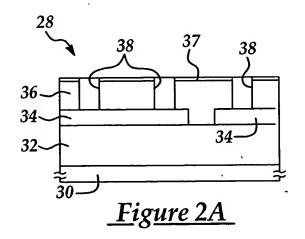
Serial No.: To Be Assigned Filed: Herewith

For: Process For Removing Tungsten Particles After Tungsten Etch-Back

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Inventor: Chih-Chun Yang

Serial No.: To Be Assigned Filed: Herewith

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